



GPM | G2C+ Alliance Company **Corporate Briefing**



2026

08/12 (Wed)

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Disclaimer

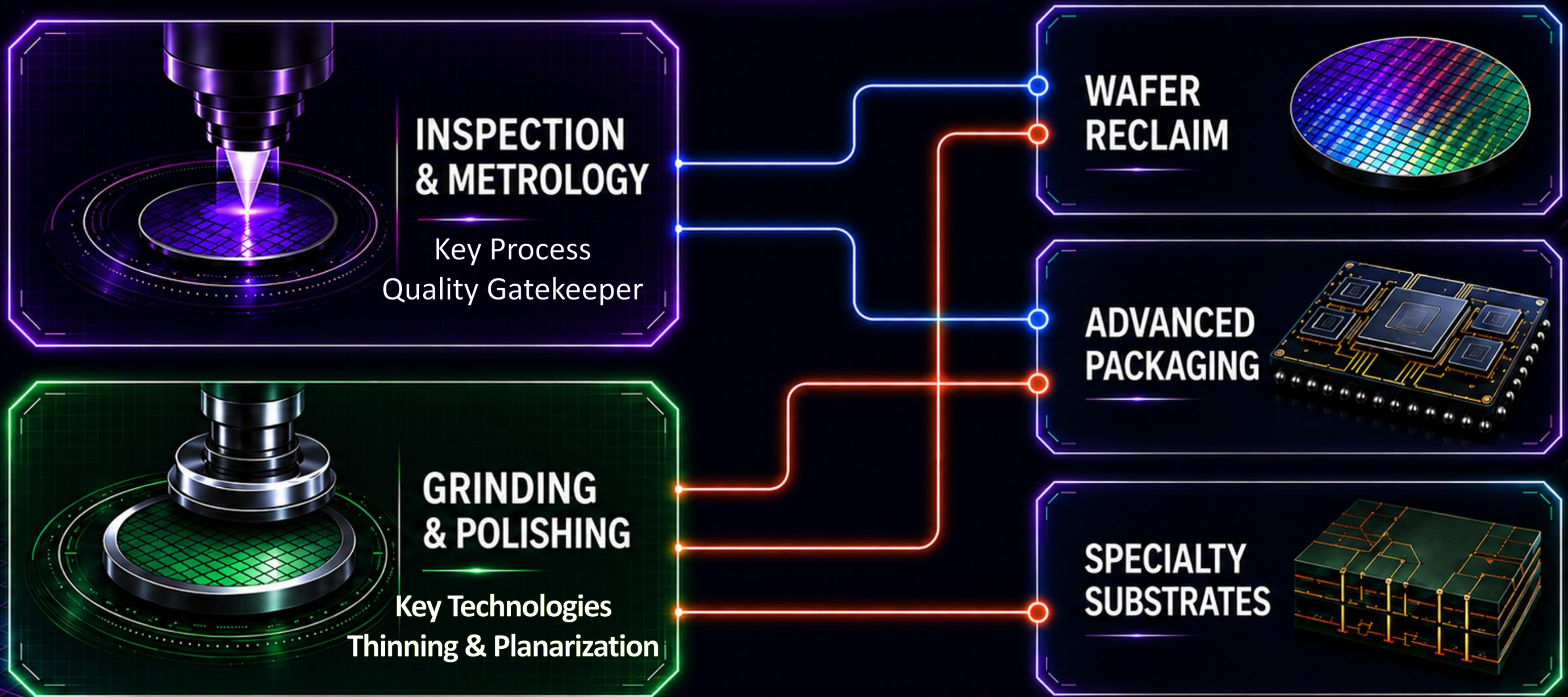
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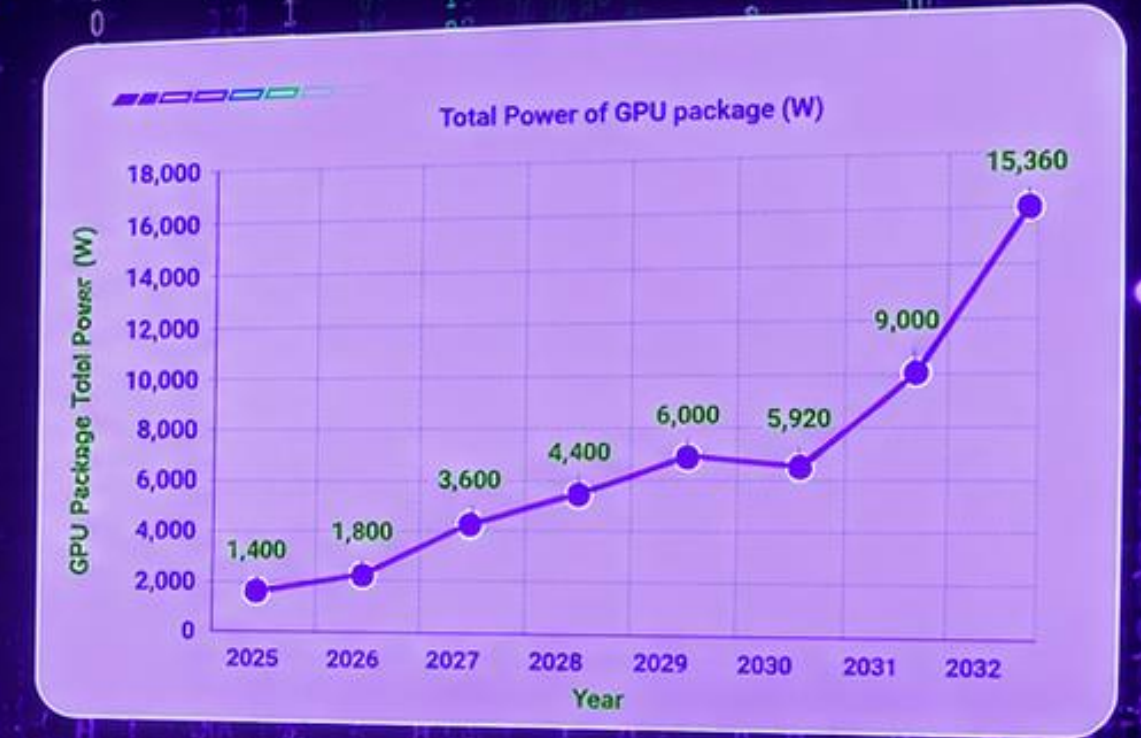
Agenda

- Dual-Core Technology Platform
- Market Trends and Product Development
- 2026Q2 Earnings Call

Dual-Core Technology Platform, Expanding into Three Key Application Markets



The High-Frequency Power Core Driving the Future of AI

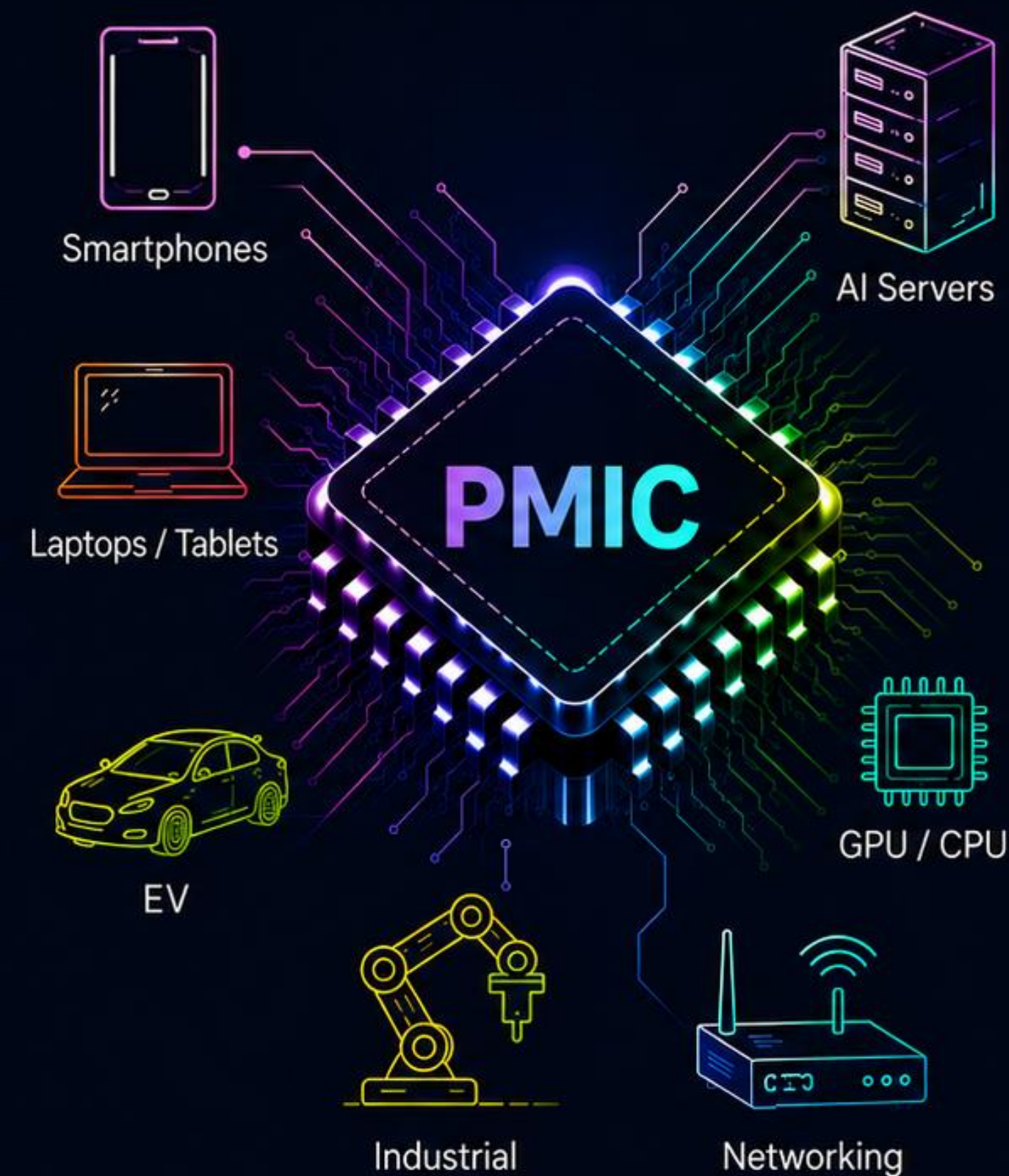


資料來源：Cisco



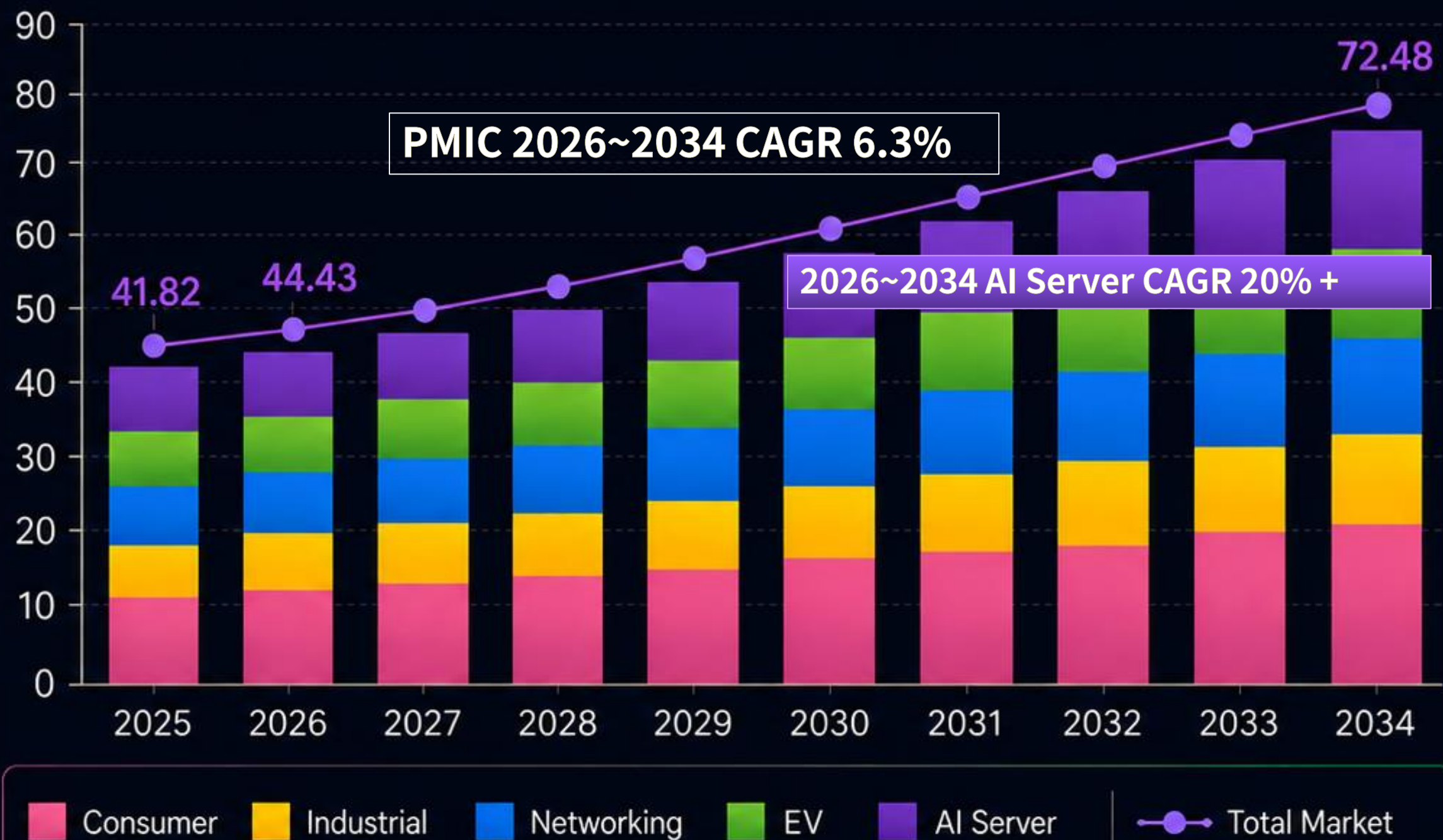
Strip Grinder

Power Management: The Key to the Future of Computing



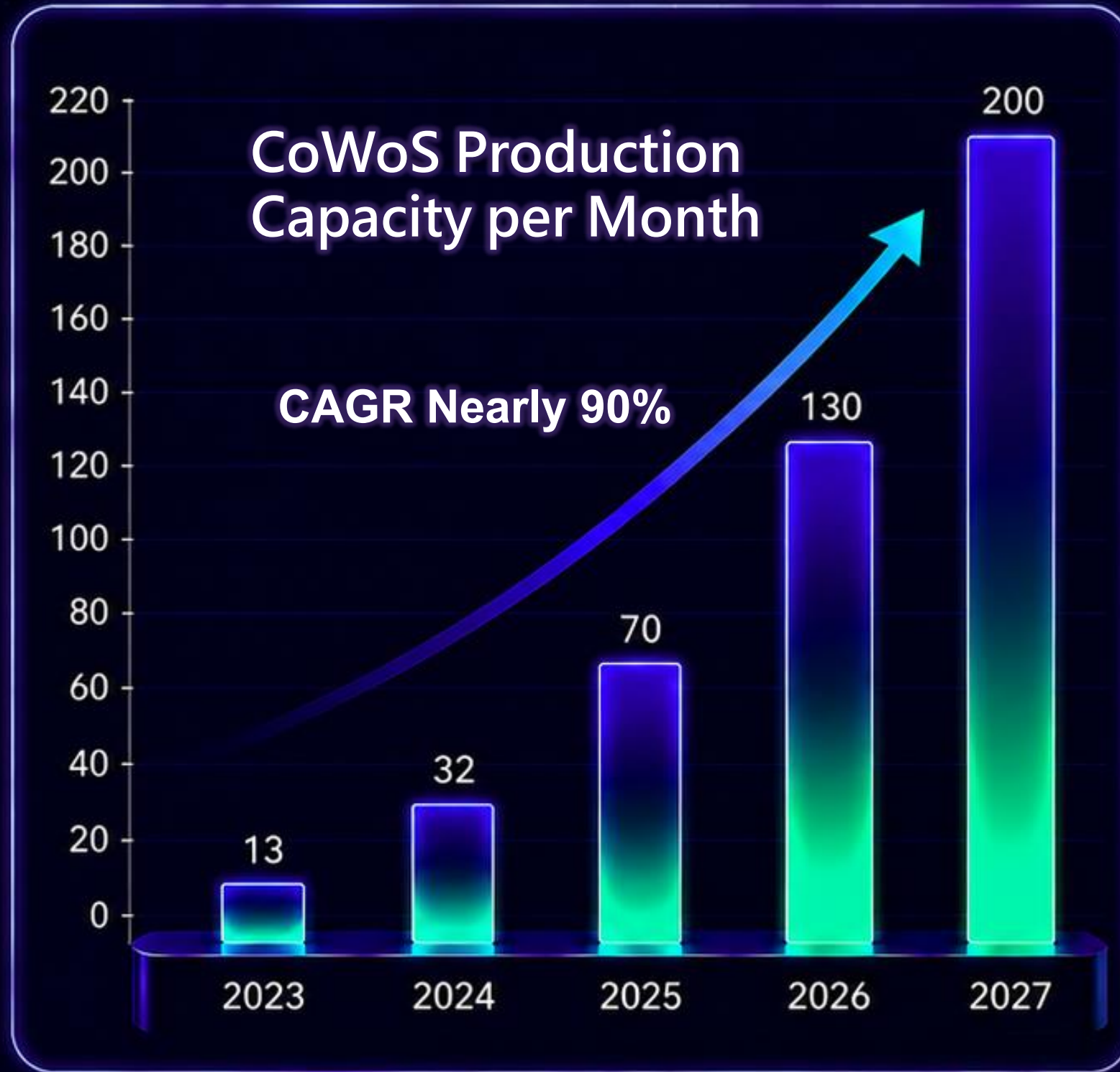
PMIC Market Size (by Application)

(US\$ Billion)

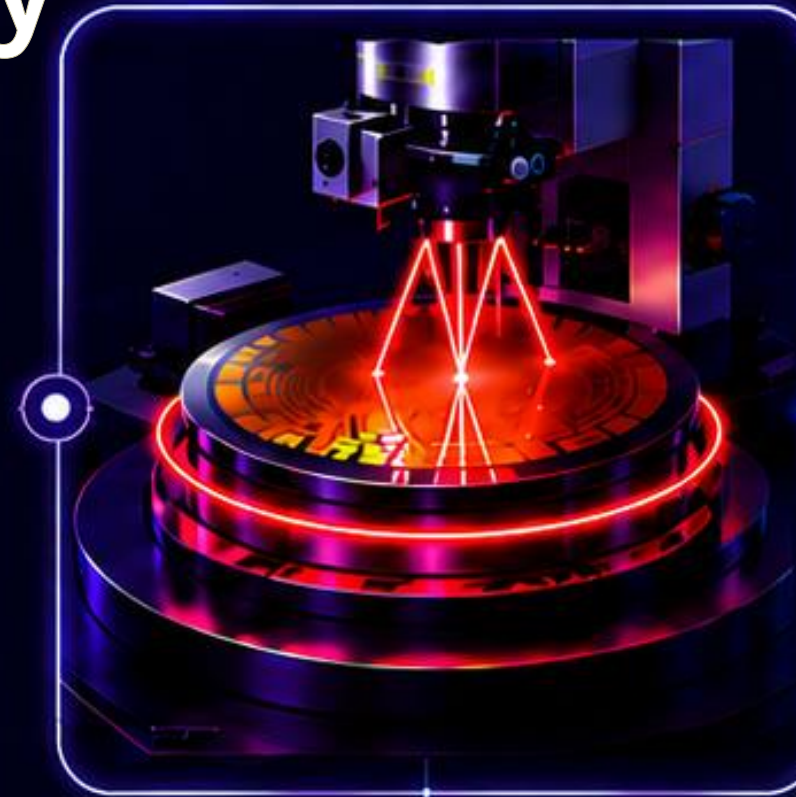


Source: [Fortune Business Insights \(2025\)](#)

Advanced Packaging Capacity Continues to Expand



Unit : K pcs Source : DIGITIMES



Carrier AOI



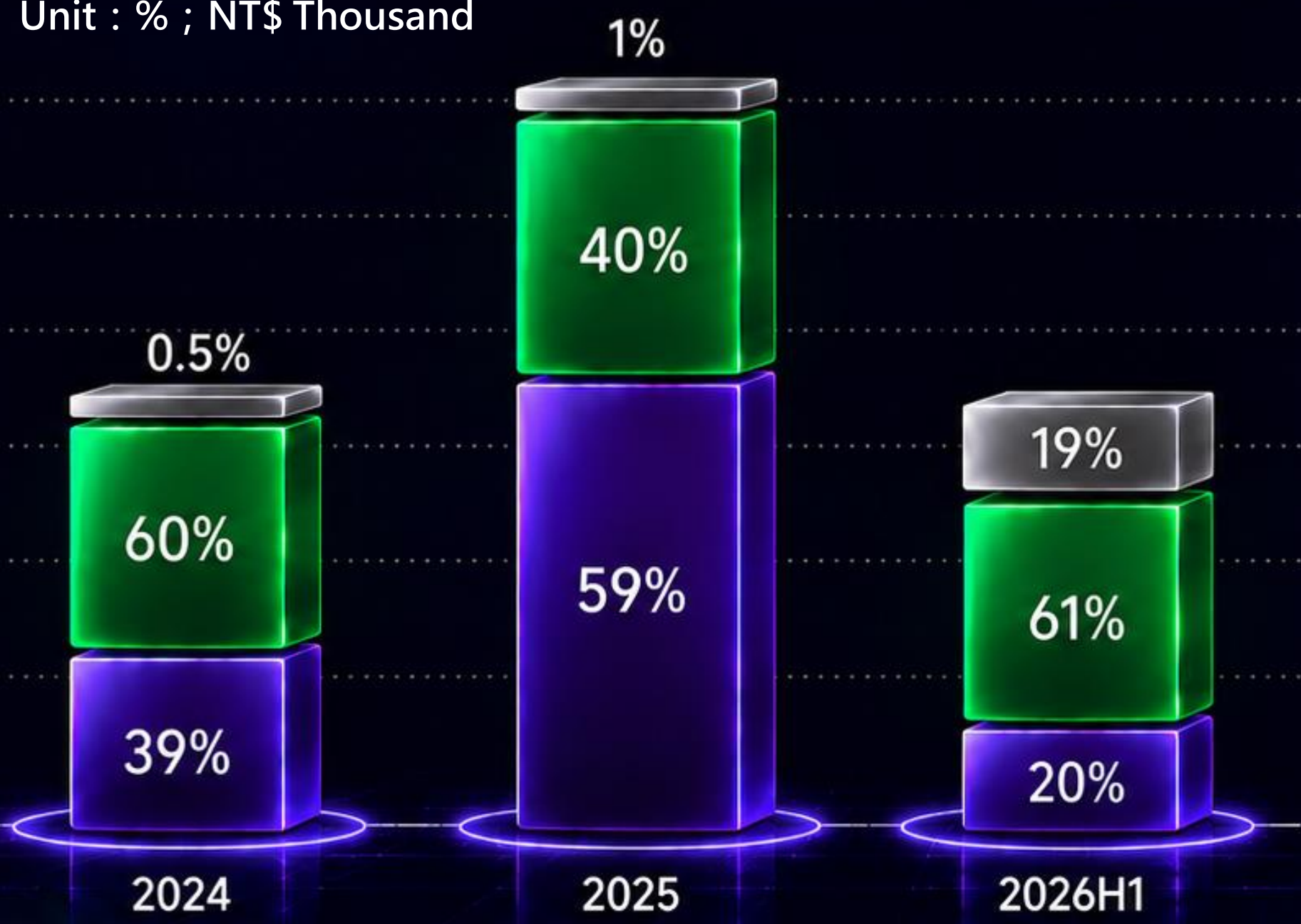
SWLI

Parent Company Semi Revenue Composition

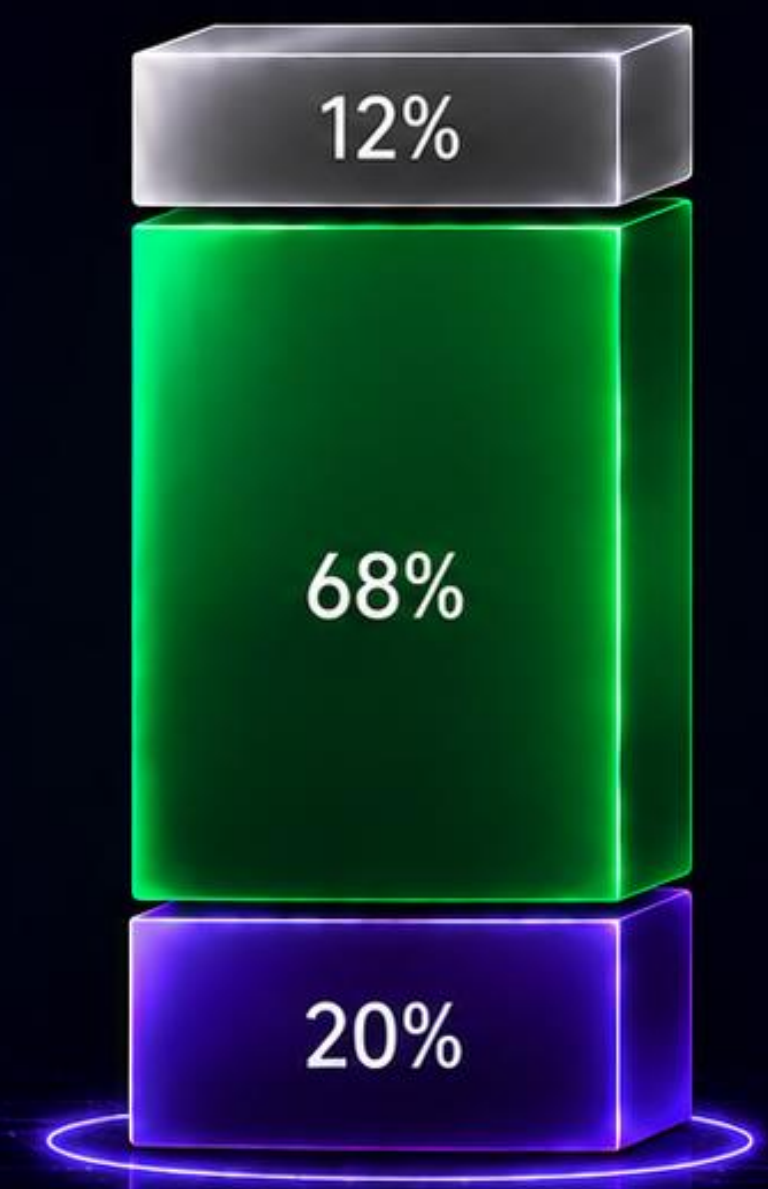
(NTD Thousands)

1,400,000
1,200,000
1,000,000
800,000
600,000
400,000
200,000
0

Unit : % ; NT\$ Thousand



2026H2 Backlog Orders



■ Wafer Reclaim ■ Advanced Packaging ■ PMIC

Consolidated Gross Margin & Semiconductor Revenue Contribution

GPM
G2C+

Unit: %

—○— Consolidated Gross Margin

■ Semiconductor Revenue
as % of Total Revenue



THANK YOU!

